## Features

| Order code | $\mathbf{V}_{\text {DSs }}$ | $\mathbf{R}_{\text {DS(on) }} \boldsymbol{m a x}$ | $\mathbf{I}_{\mathbf{D}}$ |
| :---: | :---: | :---: | :---: |
| STD25NF10LA | 100 V | $<0.035 \Omega$ | 25 A |

- Exceptional dv/dt capability

■ $100 \%$ avalanche tested

- Logic level device


## Applications

- Switching application
- Automotive


## Description

This Power MOSFET has been developed using STMicroelectronics' unique STripFET process, which is specifically designed to minimize input capacitance and gate charge. This renders the device suitable for use as primary switch in advanced high-efficiency isolated DC-DC converters for telecom and computer applications, and applications with low gate charge driving requirements.


Figure 1. Internal schematic diagram


Table 1. Device summary

| Order code | Marking | Package | Packaging |
| :---: | :---: | :---: | :---: |
| STD25NF10LA | D25NF10LA | DPAK | Tape and reel |

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## 1 <br> Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{DS}}$ | Drain-source voltage | 100 | V |
| $\mathrm{~V}_{\mathrm{GS}}$ | Gate- source voltage | $\pm 16$ | V |
| $\mathrm{I}_{\mathrm{D}}{ }^{(1)}$ | Drain current (continuous) at $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 25 | A |
| $\mathrm{I}_{\mathrm{D}}$ | Drain current (continuous) at $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ | 21 | A |
| $\mathrm{I}_{\mathrm{DM}}{ }^{(2)}$ | Drain current (pulsed) | 100 | A |
| $\mathrm{P}_{\text {tot }}$ | Total dissipation at $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 100 | W |
|  | Derating Factor | 0.67 | $\mathrm{~W} /{ }^{\circ} \mathrm{C}$ |
| $\mathrm{dv} / \mathrm{dtt}^{(3)}$ | Peak diode recovery avalanche energy | 20 | $\mathrm{~V} / \mathrm{ns}$ |
| $\mathrm{E}_{\mathrm{AS}}{ }^{(4)}$ | Single pulse avalanche energy | 450 | mJ |
| $\mathrm{~T}_{\mathrm{stg}}$ | Storage temperature | -55 to 175 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{j}}$ | Max. operating junction temperature |  |  |

1. Current limited by package
2. Pulse width limited by safe operating area.
3. $\mathrm{I}_{\mathrm{SD}} \leq 5 \mathrm{~A}, \mathrm{di} / \mathrm{dt} \leq 300 \mathrm{~A} / \mu \mathrm{s}, \mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{(\mathrm{BR}) \mathrm{DSS}}, \mathrm{T}_{\mathrm{J}} \leq \mathrm{T}_{\mathrm{JMAX}}$
4. Starting $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}, \mathrm{I}_{\mathrm{D}}=12.5 \mathrm{~A} \mathrm{~V}_{\mathrm{DD}}=50 \mathrm{~V}$

Table 3. Thermal data

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| Rthj-case | Thermal resistance junction-case max | 1.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Rthj-pcb | Thermal resistance junction-pcb max ${ }^{(1)}$ | 50 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

1. When Mounted on 1 inch2 FR-4 board, 2 oz . of Cu.

## 2 Electrical characteristics

( $\mathrm{T}_{\text {CASE }}=25^{\circ} \mathrm{C}$ unless otherwise specified)
Table 4. On/off states

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{(\mathrm{BR}) \mathrm{DSS}}$ | Drain-source <br> breakdown voltage | $\mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0$ | 100 |  |  | V |
|  | Zero gate voltage <br> drain current | $\mathrm{V}_{\mathrm{DS}}=100 \mathrm{~V}$ <br> $\mathrm{~V}_{\mathrm{DS}}=100 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ <br> $\mathrm{V}_{\mathrm{GS}}=0$ |  |  | 1 | $\mu \mathrm{~A}$ |
| $\mathrm{I}_{\mathrm{GSS}}$ | Gate-body leakage <br> current | $\mathrm{V}_{\mathrm{GS}}= \pm 16 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0$ |  |  | $\pm 100$ | nA |
| $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | Gate threshold voltage | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 1 |  | 2.5 | V |
| $\mathrm{R}_{\mathrm{DS}(\mathrm{on})}$ | Static drain-source on <br> resistance | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=12.5 \mathrm{~A}$ <br> $\mathrm{~V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=12.5 \mathrm{~A}$ |  | 0.030 | 0.035 | $\Omega$ |

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \mathrm{C}_{\text {iss }} \\ & \mathrm{C}_{\text {oss }} \\ & \mathrm{C}_{\mathrm{rss}} \end{aligned}$ | Input capacitance Output capacitance Reverse transfer capacitance | $\begin{aligned} & \mathrm{V}_{\mathrm{DS}}=25 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}, \\ & \mathrm{~V}_{\mathrm{GS}}=0 \end{aligned}$ | - | $\begin{gathered} 1710 \\ 250 \\ 110 \end{gathered}$ |  | $\begin{aligned} & \mathrm{pF} \\ & \mathrm{pF} \\ & \mathrm{pF} \end{aligned}$ |
| $t_{d(o n)}$ $t_{r}$ $t_{d \text { (off) }}$ $t_{f}$ | Turn-on delay time Rise time <br> Turn-off delay time Fall time | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=12.5 \mathrm{~A} \\ & \mathrm{R}_{\mathrm{G}}=4.7 \Omega \mathrm{~V}_{\mathrm{GS}}=5 \mathrm{~V} \\ & \text { (see Figure 13) } \end{aligned}$ | - | $\begin{aligned} & 20 \\ & 40 \\ & 58 \\ & 20 \end{aligned}$ |  | ns <br> ns <br> ns ns |
| $\begin{aligned} & \mathrm{Q}_{\mathrm{g}} \\ & \mathrm{Q}_{\mathrm{gs}} \\ & \mathrm{Q}_{\mathrm{gd}} \end{aligned}$ | Total gate charge Gate-source charge Gate-drain charge | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=80 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=25 \mathrm{~A}, \\ & \mathrm{~V}_{\mathrm{GS}}=5 \mathrm{~V}, \mathrm{R}_{\mathrm{G}}=4.7 \Omega \\ & \text { (see Figure 14) } \end{aligned}$ | - | $\begin{aligned} & 38 \\ & 8.5 \\ & 21 \end{aligned}$ | 52 | $\begin{aligned} & \mathrm{nC} \\ & \mathrm{nC} \\ & \mathrm{nC} \end{aligned}$ |

Table 6. Source drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
| :---: | :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{SD}}$ | Source-drain current |  |  |  |  |  |
| $\mathrm{I}_{\mathrm{SDM}}{ }^{(1)}$ | Source-drain current (pulsed) |  | - |  | 25 | A |
| $\mathrm{~V}_{\mathrm{SD}}{ }^{(2)}$ | Forward on voltage | $\mathrm{I}_{\mathrm{SD}}=25 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0$ | - |  | 1.5 | V |
| $\mathrm{t}_{\mathrm{rr}}$ | Reverse recovery time | $\mathrm{I}_{\mathrm{SD}}=25 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mathrm{ss}$, |  | 88 |  | ns |
| $\mathrm{Q}_{\mathrm{rr}}$ | Reverse recovery charge | $\mathrm{V}_{\mathrm{DD}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{j}}=150^{\circ} \mathrm{C}$ | - | 317 |  | nC |
| $\mathrm{I}_{\mathrm{RRM}}$ | Reverse recovery current | (see Figure 15) |  | 7.2 |  | A |

1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration $=300 \mu \mathrm{~s}$, duty cycle $1.5 \%$

### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area


Figure 4. Output characteristics

Figure 3. Thermal impedance


Figure 5. Transfer characteristics


Figure 6. Normalized breakdown voltage vs. Figure 7. Static drain-source on resistance temperature


Figure 8. Gate charge vs. gate-source voltage Figure 9. Capacitance variations


Figure 10. Normalized gate threshold voltage vs. temperature


Figure 11. Normalized on resistance vs. temperature

Figure 12. Source-drain diode forward characteristics


## 3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform


## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK ${ }^{\circledR}$ packages, depending on their level of environmental compliance. ECOPACK ${ }^{\circledR}$ specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 7. DPAK (TO-252) mechanical data

| Dim. | mm |  |  |
| :---: | :---: | :---: | :---: |
|  | Min. | Typ. | Max. |
| A | 2.20 |  | 2.40 |
| A1 | 0.90 |  | 1.10 |
| A2 | 0.03 |  | 0.23 |
| b | 0.64 |  | 0.90 |
| b4 | 5.20 |  | 5.40 |
| C | 0.45 |  | 0.60 |
| c2 | 0.48 |  | 0.60 |
| D | 6.00 |  | 6.20 |
| D1 |  | 5.10 |  |
| E | 6.40 |  | 6.60 |
| E1 |  | 4.70 |  |
| e |  | 2.28 |  |
| e1 | 4.40 |  | 4.60 |
| H | 9.35 |  | 10.10 |
| L | 1 |  | 1.50 |
| L1 |  | 2.80 |  |
| L2 |  | 0.80 |  |
| L4 | 0.60 |  | 1 |
| R |  | 0.20 |  |
| V2 | $0^{\circ}$ |  | $8^{\circ}$ |

Figure 19. DPAK (TO-252) drawing


Figure 20. DPAK footprint ${ }^{(a)}$

a. All dimensions are in millimeters

## 5 Packing mechanical data

Table 8. DPAK (TO-252) tape and reel mechanical data


Figure 21. Tape for DPAK (TO-252)


Figure 22. Reel for DPAK (TO-252)
REEL DIMENSIONS

## 6 Revision history

Table 9. Revision history

| Date | Revision | Changes |
| :---: | :---: | :--- | :--- |
| 05-Oct-2011 | 1 | First release. |

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